

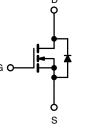


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	500				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.52			
Q _g (Max.) (nC)	52				
Q _{gs} (nC)	13				
Q _{gd} (nC)	18				
Configuration	Single				

D²PAK (TO-263)





N-Channel MOSFET

FEATURES

- Low Gate Charge Q_q results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information/tables in this datasheet for details.

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Two Transistor Forward
- Half and Full Bridge
- Power Factor Correction Boost

ORDERING INFORMATION						
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SiHFS11N50A-GE3	SiHFS11N50ATRR-GE3 ^a	SiHFS11N50ATRL-GE3 ^a			
Lead (Pb)-free	IRFS11N50APbF	IRFS11N50ATRRP ^a	IRFS11N50ATRLP ^a			

Note

a. See device orientation.

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	500	V		
Gate-Source Voltage	V _{GS}	± 30	- V		
Continuous Drain Current	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		11		
Continuous Drain Current	$T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	7.0	А	
Pulsed Drain Current ^a	I _{DM}	44	1		
Linear Derating Factor		1.3	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	275	mJ		
Repetitive Avalanche Current ^a	I _{AR}	11	А		
Repetitive Avalanche Energy ^a	E _{AR}	17	mJ		
Maximum Power Dissipation	P _D	170	W		
Peak Diode Recovery dV/dtc	dV/dt	6.9	V/ns		
Operating Junction and Storage Temperature Range	e	T _J , T _{stg}	- 55 to + 150		
Soldering Recommendations (Peak Temperature) ^d	for 10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25 \text{ °C}$, L = 4.5 mH, $R_g = 25 \Omega$, $I_{AS} = 11 \text{ A}$ (see fig. 12). c. $I_{SD} \le 11 \text{ A}$, $dI/dt \le 140 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.



RoHS³

HALOGEN FREE



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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.75				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W			
Maximum Junction-to-Ambient	R _{thJA}	-	62				

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		1				muu	
Drain-Source Breakdown Voltage	V _{DS}	VGS	_s = 0, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I _D = 1 mA		-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	-	$V_{GS} = \pm 30 \text{ V}$		-	± 100	nA
		V _{DS} :	V _{DS} = 500 V, V _{GS} = 0 V		-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.6 A ^b	-	-	0.52	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 6.6 A	6.1	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	1423	-	
Output Capacitance	C _{oss}		V _{DS} = 25 V,	-	208	-	
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	8.1	-	pF
	C _{oss}	V _{GS} = 0 V	V _{DS} = 1.0 V, f = 1.0 MHz	-	2000	-	р
Output Capacitance			V _{DS} = 400 V, f = 1.0 MHz	-	55	-	
Effective Output Capacitance	Coss eff.	-	$V_{DS} = 0 V \text{ to } 400 V^{c}$	-	97	-	
Total Gate Charge	Qg			-	-	52	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 11 A, V _{DS} = 400 V see fig. 6 and 13 ^b	-	-	13	
Gate-Drain Charge	Q _{gd}	-	ooo ng. o ana ro	-	-	18	
Turn-On Delay Time	t _{d(on)}		1	-	14	-	
Rise Time	t _r		= 250 V, I _D = 11 A	-	35	-	
Turn-Off Delay Time	t _{d(off)}	R _g =	9.1 Ω , R _D = 22 Ω , see fig. 10 ^b	-	32	-	ns
Fall Time	t _f		g	-	28	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym	bol	-	-	11	
Pulsed Diode Forward Current ^a	I _{SM}	integral revers	showing the integral reverse p - n junction diode		-	44	A
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A, V _{GS} = 0 V ^b	-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}			-	510	770	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	= = 11 A, dl/dt = 100 A/μs ^b	-	3.4	5.1	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	vland	1

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising fom 0 % V_{DS} to 80 % V_{DS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

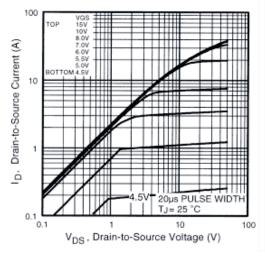


Fig. 1 - Typical Output Characteristics

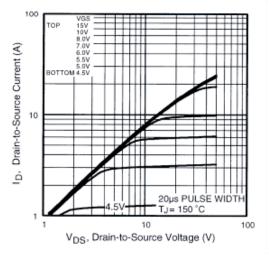


Fig. 2 - Typical Output Characteristics

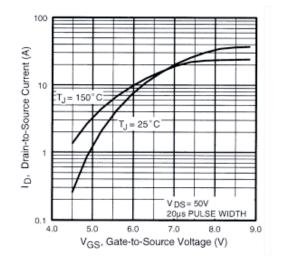


Fig. 3 - Typical Transfer Characteristics

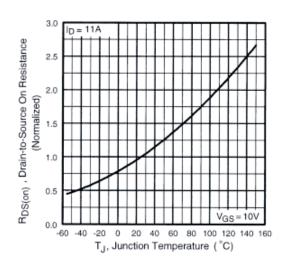
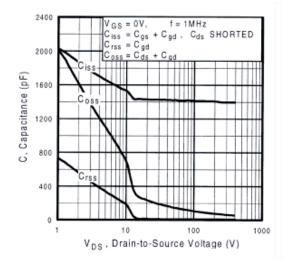


Fig. 4 - Normalized On-Resistance vs. Temperature

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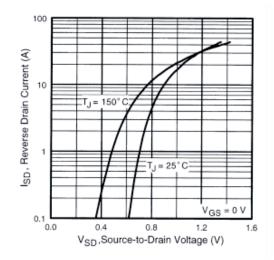


Fig. 7 - Typical Source-Drain Diode Forward Voltage

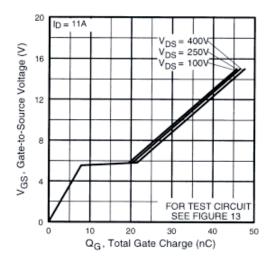


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

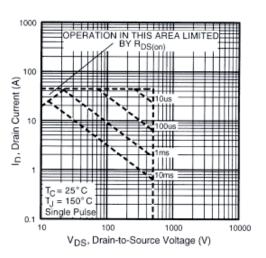


Fig. 8 - Maximum Safe Operating Area

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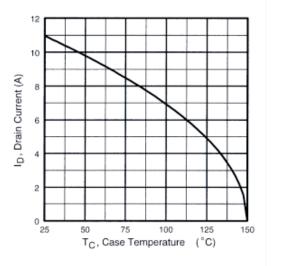


Fig. 9 - Maximum Drain Current vs. Case Temperature

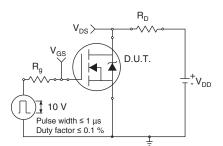


Fig. 10a - Switching Time Test Circuit

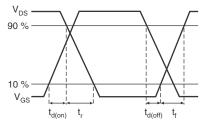
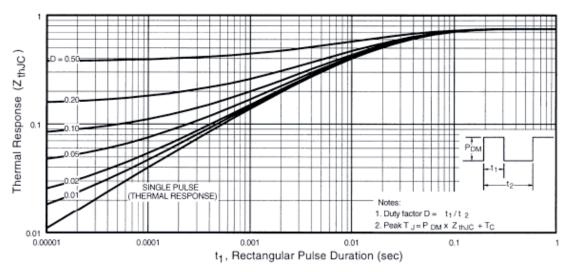


Fig. 10b - Switching Time Waveforms





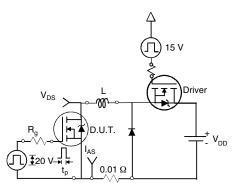
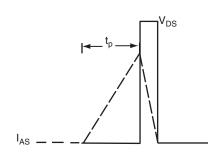
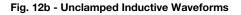


Fig. 12a - Unclamped Inductive Test Circuit





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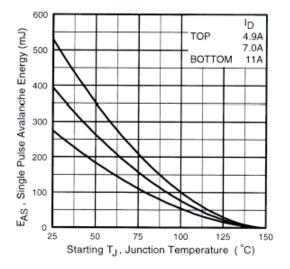


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

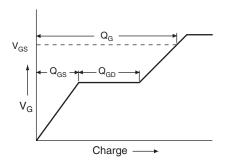


Fig. 13a - Basic Gate Charge Waveform

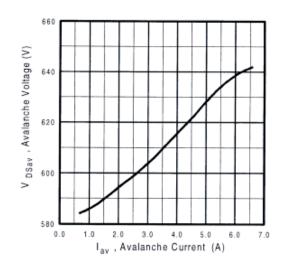


Fig. 12d - Typical Drain-to-Source Voltage vs. Avalanche Current

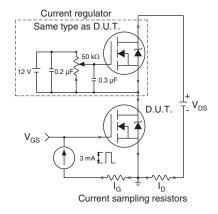


Fig. 13b - Gate Charge Test Circuit





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Peak Diode Recovery dV/dt Test Circuit

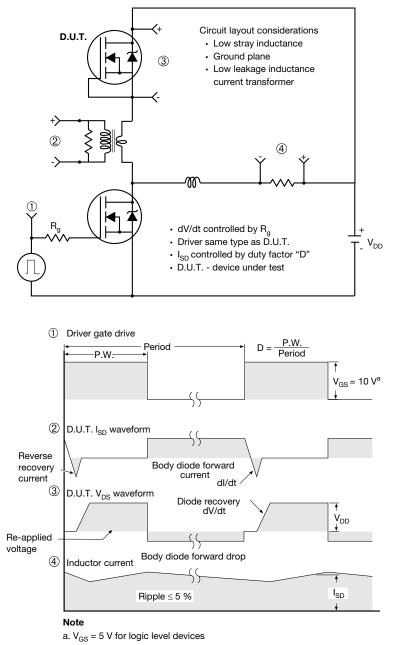


Fig. 14 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>	
	MILLIN	IETERS	INCHES				MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
				0.010		-		10.07	0.000	0.420
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-
							6.22	- 10.67 - BSC	0.245	- BSC
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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